## **Surface Mount Schottky Power Rectifier**

#### **SMA Power Surface Mount Package**

... employing the Schottky Barrier principle in a metal-to-silicon power rectifier. Features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency switching power supplies; free wheeling diodes and polarity protection diodes. Typical applications are ac/dc and dc-dc converters, reverse battery protection, and "Oring" of multiple supply voltages and any other application where performance and size are critical.

- Ultra Low V<sub>F</sub>
- 1st in the Market Place with a 10 V<sub>R</sub> Schottky Rectifier
- Compact Package with J-Bend Leads Ideal for Automated Handling
- Highly Stable Oxide Passivated Junction
- Guardring for Over-Voltage Protection
- Optimized for Low Forward Voltage

#### Mechanical Characteristics:

- Case: Molded Epoxy
- Epoxy Meets UL94, V<sub>O</sub> at 1/8"
- Weight: 70 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: Polarity Band Indicates Cathode Lead
- ESD Ratings: Machine Model = C

  Human Body Model = 3A
- Available in 12 mm Tape, 5000 Units per 13 inch Reel
- Marking: B2L1

#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	10	V
Average Rectified Forward Current (At Rated V <sub>R</sub> , T <sub>L</sub> = 110°C)	lo	2.0	Α
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	160	A
Storage/Operating Case Temperature Operating Junction Temperature	$T_{stg}, T_{C}$ $T_{J}$	-55 to +125	°C
Voltage Rate of Change (Rated V <sub>R</sub> , T <sub>J</sub> = 25°C)	dv/dt	10,000	V/µs



#### ON Semiconductor®

http://onsemi.com

# SCHOTTKY BARRIER RECTIFIER 2 AMPERES 10 VOLTS



**PLASTIC** 

## DIAGRAM B2L1

**MARKING** 

B2L1 = Device Code

#### **ORDERING INFORMATION**

Device Package		Shipping
MBRA210LT3	SMA	5000/Tape & Reel

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Min Pad	1 Inch Pad	Unit
Thermal Resistance - Junction-to-Lead	$R_{\theta JL}$	22	15	°C/W
Thermal Resistance - Junction-to-Ambient	$R_{\theta JA}$	150	81	

#### **ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (Note 1)	V <sub>F</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	V
$(I_F = 0.1 \text{ A})$ $(I_F = 1.0 \text{ A})$ $(I_F = 2.0 \text{ A})$		0.260 0.325 0.350	0.15 0.23 0.26	
Maximum Instantaneous Reverse Current	I <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	mA
$(V_R = 5.0 \text{ V})$ $(V_R = 10 \text{ V})$		0.25 0.70	40 60	

<sup>1.</sup> Pulse Test: Pulse Width  $\leq$  250  $\mu s, \, Duty \, Cycle \leq$  2%.

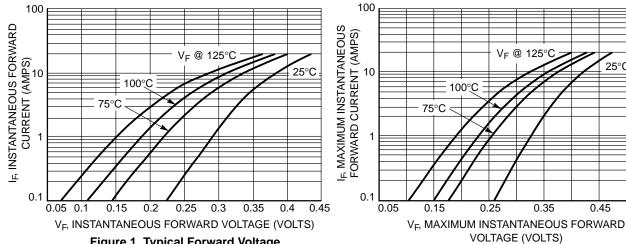


Figure 1. Typical Forward Voltage

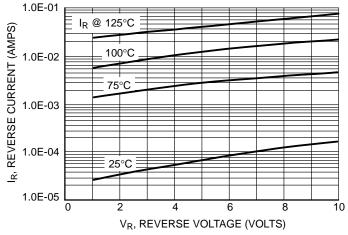
Figure 2. Maximum Forward Voltage

0.35

25°C

0.45

0.55



**Figure 3. Typical Reverse Current** 

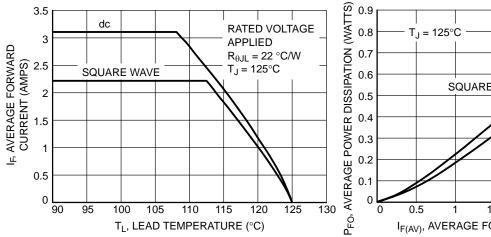


Figure 4. Current Derating - Junction to Lead

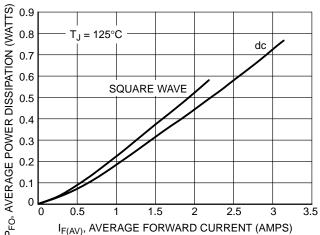


Figure 5. Forward Power Dissipation

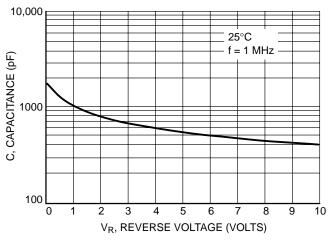


Figure 6. Typical Capacitance

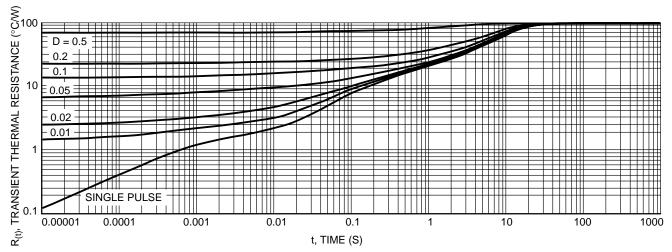


Figure 7. Thermal Response, Junction to Ambient (min pad)

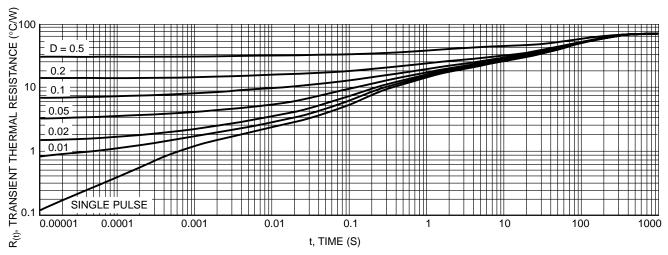
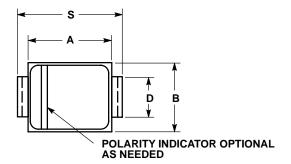


Figure 8. Thermal Response, Junction to Ambient (1 inch pad)

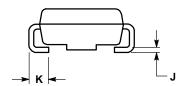
#### **PACKAGE DIMENSIONS**

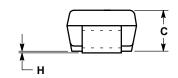
SMA CASE 403D-02 ISSUE A

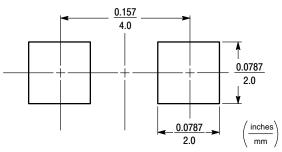


- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. 403D-01 OBSOLETE, NEW STANDARD IS 403D-02.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN MAX	
Α	0.160	0.180	4.06	4.57
В	0.090	0.115	2.29	2.92
С	0.075	0.095	1.91	2.41
D	0.050	0.064	1.27	1.63
Н	0.002	0.006	0.05	0.15
J	0.006	0.016	0.15	0.41
K	0.030	0.060	0.76	1.52
S	0.190	0.220	4.83	5.59







**SMA FOOTPRINT** 

## **Notes**

## **Notes**

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